

NB7LQ572

2.5V / 3.3V Differential 4:1 Mux w/Input Equalizer to 1:2 LVPECL Clock/Data Fanout / Translator

Multi-Level Inputs w/ Internal Termination

The NB7LQ572 is a high performance differential 4:1 Clock/Data input multiplexer and a 1:2 LVPECL Clock / Data fanout buffer that operates up to 7 GHz / 11 Gbps respectively with a 2.5 V or 3.3 V power supply.

Each IN_x/IN_x input pair incorporates a fixed Equalizer Receiver, which when placed in series with a Data path, will enhance the degraded signal transmitted across an FR4 backplane or cable interconnect. For applications that do not require Equalization, consider the NB7L572, which is pin-compatible to the NB7LQ572.

The differential Clock / Data inputs have internal 50 Ω termination resistors and will accept differential LVPECL, CML, or LVDS logic levels. The NB7LQ572 incorporates a pair of Select pins that will choose one of four differential inputs and will produce two identical LVPECL output copies of Clock or Data. As such, the NB7LQ572 is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The two differential LVPECL outputs will swing 750 mV when externally loaded and terminated with a 50 Ω resistor to $V_{CC} - 2\text{ V}$ and are optimized for low skew and minimal jitter.

The NB7LQ572 is offered in a low profile 5x5 mm 32-pin QFN Pb-Free package. Application notes, models, and support documentation are available at www.onsemi.com.

The NB7LQ572 is a member of the GigaComm™ family of high performance clock products.

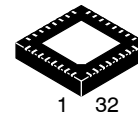
Features

- Input Data Rate > 11 Gb/s Typical
- Data Dependent Jitter < 10 ps
- Maximum Input Clock Frequency > 7 GHz Typical
- Random Clock Jitter < 0.8 ps RMS
- Fixed Input Equalization
- Low Skew 1:2 LVPECL Outputs, < 15 ps max
- 4:1 Multi-Level Mux Inputs, accepts LVPECL, CML, LVDS
- 160 ps Typical Propagation Delay
- 50 ps Typical Rise and Fall Times
- Differential LVPECL Outputs, 800 mV peak-to-peak, typical
- Operating Range: 2.5 $\pm 5\%$ or 3.3 V $\pm 10\%$
- Internal 50 Ω Input Termination Resistors
- V_{REFAC} Reference Output
- QFN-32 Package, 5mm x 5mm
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



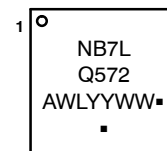
ON Semiconductor®

<http://onsemi.com>



QFN32
MN SUFFIX
CASE 488AM

MARKING DIAGRAM



A	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
▪	= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 11 of this data sheet.

NB7LQ572

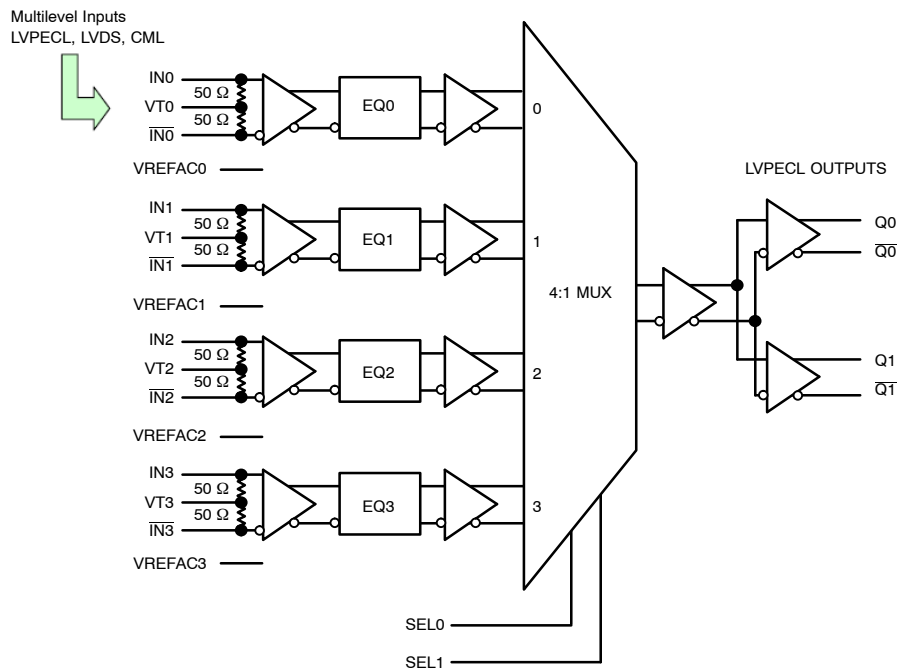


Figure 1. Simplified Block Diagram

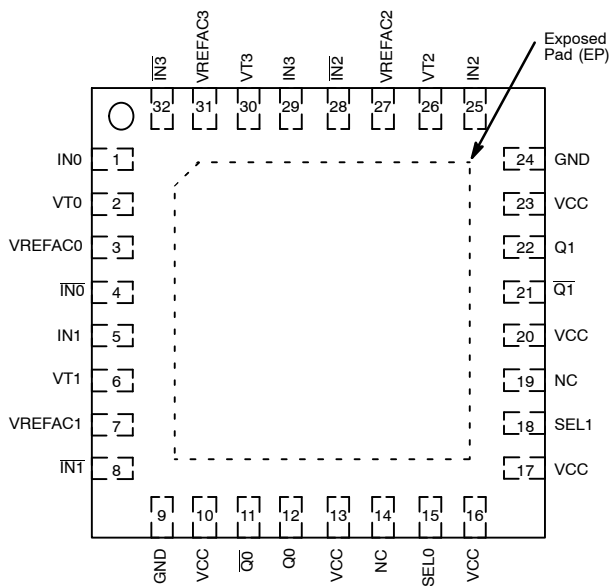


Figure 2. Pinout: QFN-32 (Top View)

Table 1. Input Select Function Table

SEL1*	SEL0*	Clock / Data Input Selected
0	0	IN0 Input Selected
0	1	IN1 Input Selected
1	0	IN2 Input Selected
1	1	IN3 Input Selected

*Defaults HIGH when left open.

Table 2. PIN DESCRIPTION

Pin Number	Pin Name	I/O	Pin Description
1, 4 5, 8 25, 28 29, 32	IN0, $\overline{\text{IN0}}$ IN1, $\overline{\text{IN1}}$ IN2, $\overline{\text{IN2}}$ IN3, $\overline{\text{IN3}}$	LVPECL, CML, LVDS Input	Noninverted, Inverted, Differential Clock or Data Inputs
2, 6 26, 30	VT0, VT1 VT2, VT3		Internal 100 Ω Center-tapped Termination Pin for INx / $\overline{\text{INx}}$
15 18	SEL0 SEL1	LVTTTL/LVCMOS Input	Input Select pins, default HIGH when left open through a 94 k Ω pullup resistor. Input logic threshold is $V_{CC} / 2$. See Select Function, Table 1.
14, 19	NC	–	No Connect
10, 13, 16 17, 20, 23	V_{CC}	–	Positive Supply Voltage.
11, 12 21, 22	$\overline{\text{Q0}}$, Q0 $\overline{\text{Q1}}$, Q1	LVPECL Output	Non-inverted, Inverted Differential Outputs.
9, 24	GND		Negative Supply Voltage
3 7 27 31	VREFAC0 VREFAC1 VREFAC2 VREFAC3	–	Output Voltage Reference for Capacitor-Coupled Inputs
–	EP	–	The Exposed Pad (EP) on the QFN-32 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically connected to GND.

1. In the differential configuration when the input termination pins (VT0, VT1, VT2, VT3) are connected to a common termination voltage or left open, and if no signal is applied on INx/ $\overline{\text{INx}}$ input, then the device will be susceptible to self-oscillation.
2. All V_{CC} and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characteristics	Value
ESD Protection Human Body Model Machine Model	> 2 kV > 200 V
R _{PU} – SELx Input Pullup Resistor	56 kΩ
Moisture Sensitivity (Note 3) QFN–32	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in
Transistor Count	268
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		–0.5 to +4.0	V
V _{IN}	Positive Input Voltage	GND = 0 V		–0.5 to V _{CC} +0.5	V
V _{INPP}	Differential Input Voltage I _N – I _N			1.89	V
I _{OUT}	LVPECL Output Current	Continuous Surge		50 100	mA
I _{IN}	Input current Through RT (50 Ω resistor)			± 40	mA
I _{VREFAC}	V _{REFAC} Sink or Source Current			± 1.5	mA
T _A	Operating Temperature Range			–40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ _{JA}	Thermal Resistance (Junction–to–Ambient) (Note 4)	0 lfpm 500 lfpm	QFN–32 QFN–32	31 27	°C/W
θ _{JC}	Thermal Resistance (Junction–to–Case) (Note 4)		QFN–32	12	°C/W
T _{sol}	Wave Solder	≤ 20 sec		265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

Table 5. DC CHARACTERISTICS POSITIVE LVPECL OUTPUT $V_{CC} = 2.375 \text{ V to } 2.625 \text{ V, } 3.0 \text{ V to } 3.6 \text{ V, GND} = 0 \text{ V,}$
 $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ (Note 5)

Symbol	Characteristic	Min	Typ	Max	Unit
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POWER SUPPLY

V_{CC}	Power Supply Voltage $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 3.3 \text{ V}$	2.375 3.0	2.5 3.3	2.625 3.6	V
I_{CC}	Power Supply Current for V_{CC} (Inputs and Outputs Open)		100	125	mA

LVPECL OUTPUTS

V_{OH}	Output HIGH Voltage (Note 6) $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 3.3 \text{ V}$	$V_{CC} - 1145$ 1355 2155	$V_{CC} - 900$ 1600 2400	$V_{CC} - 800$ 1700 2500	mV
V_{OL}	Output LOW Voltage (Note 6) $V_{CC} = 2.5 \text{ V}$ $V_{CC} = 3.3 \text{ V}$	$V_{CC} - 2000$ 500 1300	$V_{CC} - 1700$ 800 1600	$V_{CC} - 1500$ 1000 1800	mV

DIFFERENTIAL CLOCK INPUTS DRIVEN SINGLE-ENDED (Note 7) (Figures 9 and 10)

V_{IH}	Single-ended Input HIGH Voltage	$V_{th} + 100$		V_{CC}	mV
V_{IL}	Single-ended Input LOW Voltage	GND		$V_{th} - 100$	mV
V_{th}	Input Threshold Reference Voltage Range (Note 8)	1100		$V_{CC} - 100$	mV
V_{ISE}	Single-ended Input Voltage ($V_{IH} - V_{IL}$)	200		V_{CC}	mV

VREFAC

V_{REFAC}	Output Reference Voltage (100 μA Load)	$V_{CC} - 1300$	$V_{CC} - 1100$	$V_{CC} - 900$	mV
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DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (Note 9) (Figures 11 and 12)

V_{IHD}	Differential Input HIGH Voltage ($I_{N_x}, \overline{I_{N_x}}$)	1200		V_{CC}	mV
V_{ILD}	Differential Input LOW Voltage ($I_{N_x}, \overline{I_{N_x}}$)	0		$V_{IHD} - 100$	mV
V_{ID}	Differential Input Voltage ($I_{N_x}, \overline{I_{N_x}}$) ($V_{IHD} - V_{ILD}$)	100		1200	mV
V_{CMR}	Input Common Mode Range (Differential Configuration) (Note 10) (Figure 13)	1150		$V_{CC} - 50$	mV
I_{IH}	Input HIGH Current $I_{N_x}/\overline{I_{N_x}}$ ($V_{T_x}/\overline{V_{T_x}}$ Open)	-150		150	μA
I_{IL}	Input LOW Current $I_{N_x}/\overline{I_{N_x}}$ ($V_{T_x}/\overline{V_{T_x}}$ Open)	-150		150	μA

CONTROL INPUT (SELx Pin)

V_{IH}	Input HIGH Voltage for Control Pin	2.0		V_{CC}	V
V_{IL}	Input LOW Voltage for Control Pin	GND		0.8	V
I_{IH}	Input HIGH Current	-150		150	μA
I_{IL}	Input LOW Current	-150		150	μA

TERMINATION RESISTORS

R_{TIN}	Internal Input Termination Resistor (Measured from I_{N_x} to V_{T_x})	45	50	55	Ω
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NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

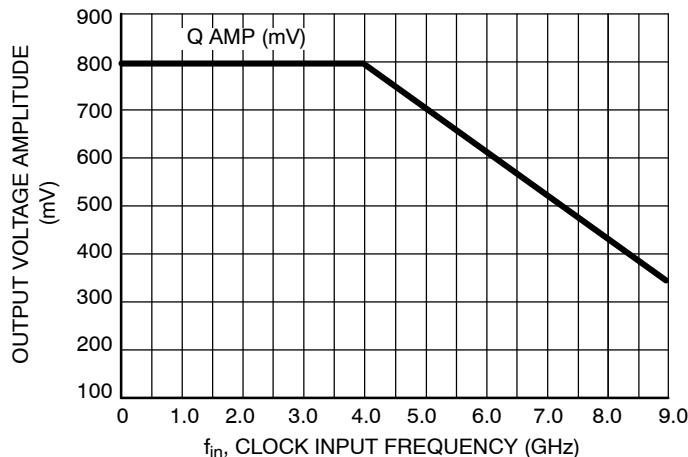
- Input and Output parameters vary 1:1 with V_{CC} .
- LVPECL outputs loaded with 50 Ω to $V_{CC} - 2 \text{ V}$ for proper operation.
- V_{th} , V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.
- V_{th} is applied to the complementary input when operating in single-ended mode.
- V_{IHD} , V_{ILD} , V_{ID} and V_{CMR} parameters must be complied with simultaneously.
- V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the most positive side of the differential input signal.

Table 6. AC CHARACTERISTICS $V_{CC} = 2.375\text{ V to }2.625\text{ V, }3.0\text{ V to }3.6\text{ V, GND} = 0\text{ V, }T_A = -40^{\circ}\text{C to }+85^{\circ}\text{C}$ (Note 11)

Symbol	Characteristic	Min	Typ	Max	Unit
f_{MAX}	Maximum Input Clock Frequency $V_{OUT} \geq 400\text{ mV}$	6	7		GHz
$f_{DATAMAX}$	Maximum Operating Data Rate NRZ, (PRBS23)	10	11		Gbps
f_{SEL}	Maximum Toggle Frequency, SELx	4	10		MHz
V_{OUTPP}	Output Voltage Amplitude (@ $V_{INPPmin}$) $f_{in} \leq 6\text{ GHz}$ (Note 11) (Figures 3 and 14)	400	800		mV
t_{PLH} , t_{PHL}	Propagation Delay to Differential Outputs Measured at Differential Crosspoint $INx/\overline{INx}$ to $Qx/\overline{Qx}$ @1 GHz @ 50 MHz SELn to Qx	75	160 5	250 10	ps ns
$t_{PD Tempco}$	Differential Propagation Delay Temperature Coefficient		100		$\Delta fs/^{\circ}C$
t_{skew}	Output – Output skew (within device) (Note 13) Device – Device skew ($t_{pdmax} - t_{pdmin}$)		0 30	15 100	ps
t_{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} = 1\text{ GHz}$	45	50	55	%
Φ_N	Phase Noise, $f_C = 1\text{ GHz}$ 10 kHz 100 kHz 1 MHz 10 MHz 20 MHz		-135 -136 -148 -148 -148		dBc
$t_{JIT(\Phi)}$	Phase Jitter (RMS) (Figure 7) $f_C = 1\text{ GHz, }12\text{ kHz} - 20\text{ MHz}$		40		fs
t_{JITTER}	Random Clock Jitter, RJ(RMS), (Note 14) $f_{IN} \leq 7\text{ GHz}$ Deterministic Jitter, DJ (Note 15) $f_{IN} \leq 10\text{ Gbps}$		0.2	0.8 10	ps
	Crosstalk Induced Jitter (RMS) (Adjacent Channel) (Note 16)			0.7	ps
V_{INPP}	Input Voltage Swing (Differential Configuration) (Note 17)	100		1200	mV
t_r, t_f	Output Rise/Fall Times @ 1 GHz; (20% – 80%), Qx, $\overline{Qx}$	25	50	75	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured using a $V_{INPPmin}$ source, 50% duty cycle clock source. All output loading with external $50\ \Omega$ to $V_{CC} - 2\text{ V}$. Input edge rates 40 ps (20% – 80%).
12. Output voltage swing is a single-ended measurement operating in differential mode.
13. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the cross-point of the outputs.
14. Additive RMS jitter with 50% duty cycle clock signal.
15. Additive Peak-to-Peak data dependent jitter with input NRZ data at PRBS23.
16. Crosstalk is measured at the output while applying two similar clock frequencies that are asynchronous with respect to each other at the inputs.
17. Input voltage swing is a single-ended measurement operating in differential mode.

**Figure 3. Clock Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)**

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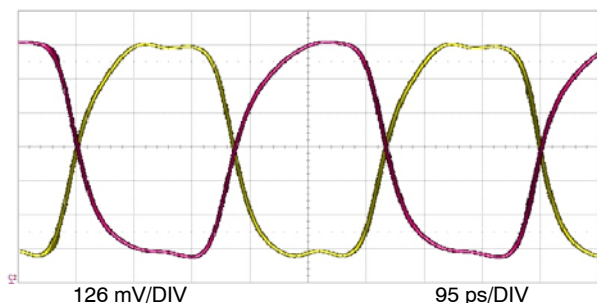


Figure 4. Typical Output Waveform at 2 GHz
($V_{INPP} = 175 \text{ mV}$, $V_{CC} = 2.38 \text{ V}$)

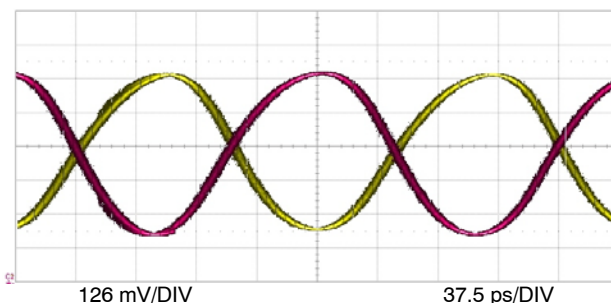


Figure 5. Typical Output Waveform at 5 GHz
($V_{INPP} = 175 \text{ mV}$, $V_{CC} = 2.38 \text{ V}$)

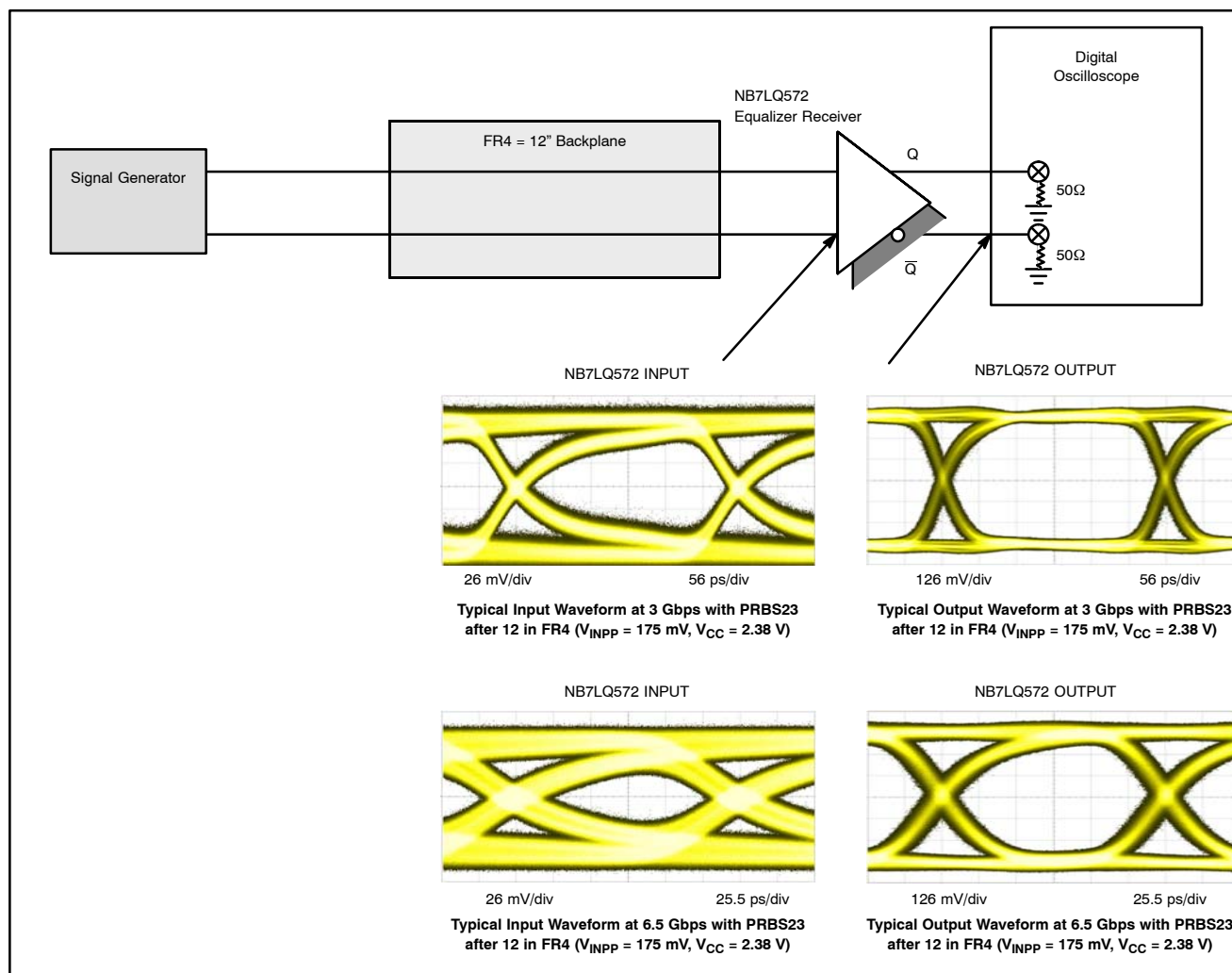


Figure 6. Typical NB7LQ572 Equalizer Application and Interconnect; Eye Diagrams with PRBS23 Pattern at 3 Gbps and 6.5 Gbps after 12 inches of FR4

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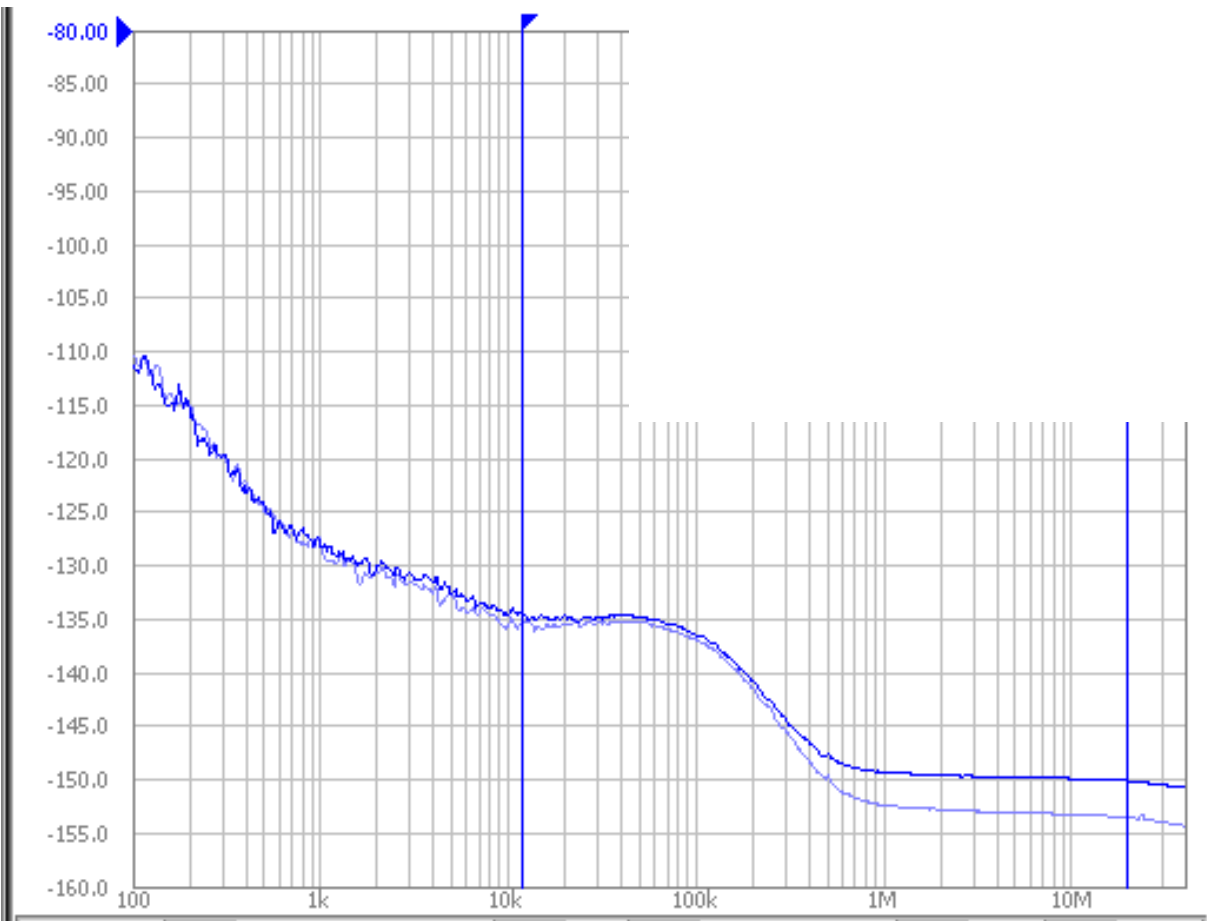


Figure 7. Typical Phase Noise Plot at $f_{\text{carrier}} = 1 \text{ GHz}$

The phase noise plot was captured using an Agilent E5052A which shows additive phase noise of the NB7LQ572 at 1 GHz, an operating voltage of 2.5 V at room temperature. The RMS Phase Jitter contributed by the device (integrated between 12 kHz and 20 MHz) is 35 fs. The input source used for the phase noise measurement is an Agilent E8663B.

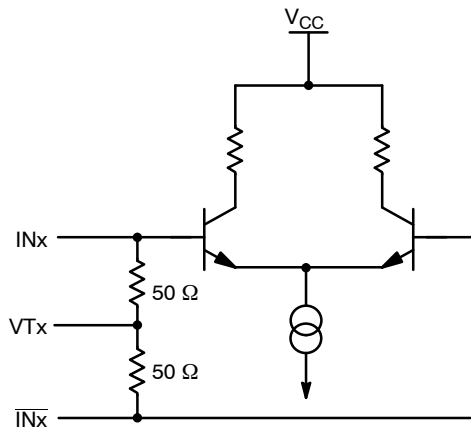


Figure 8. Input Structure

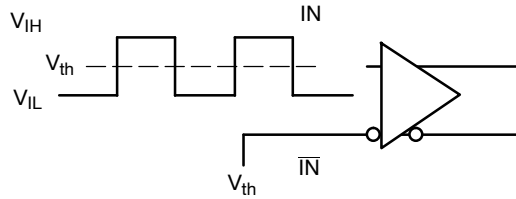


Figure 9. Differential Input Driven Single-Ended

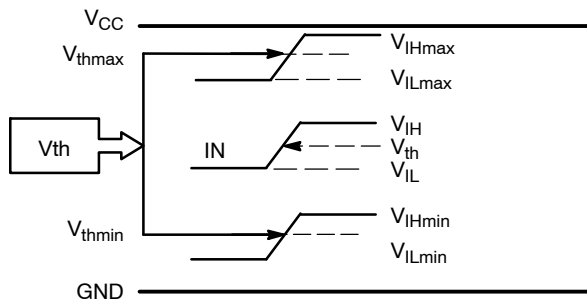


Figure 10. V_{th} Diagram

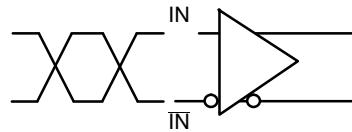


Figure 11. Differential Inputs Driven Differentially

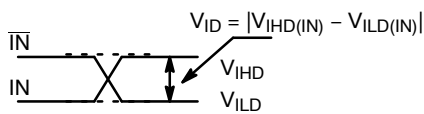


Figure 12. Differential Inputs Driven Differentially

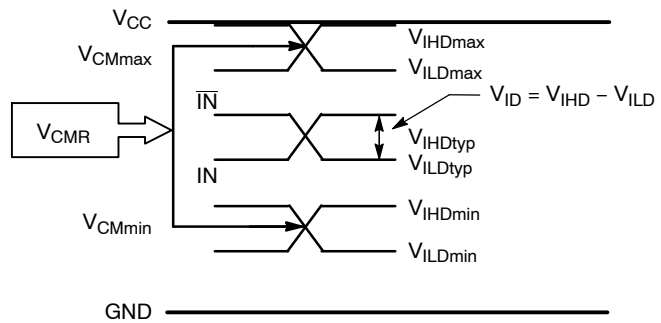


Figure 13. V_{CMR} Diagram

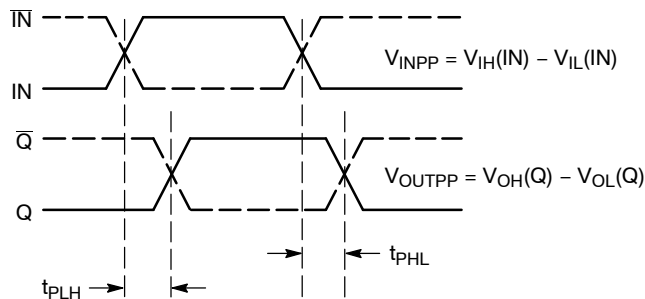


Figure 14. AC Reference Measurement

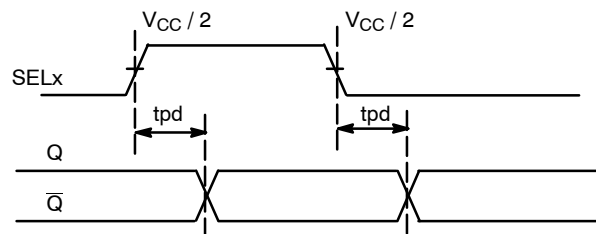


Figure 15. SELx to Qx Timing Diagram

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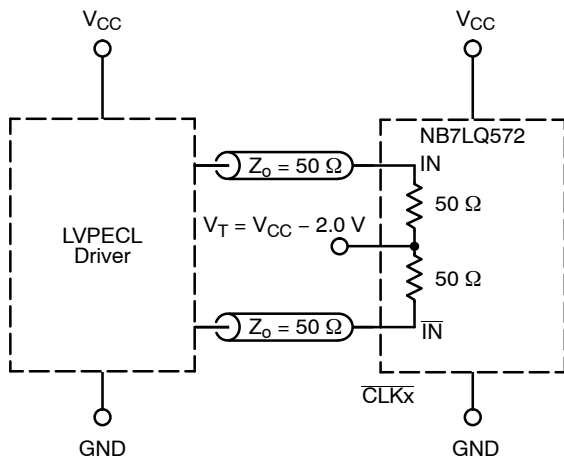


Figure 16. LVPECL Interface

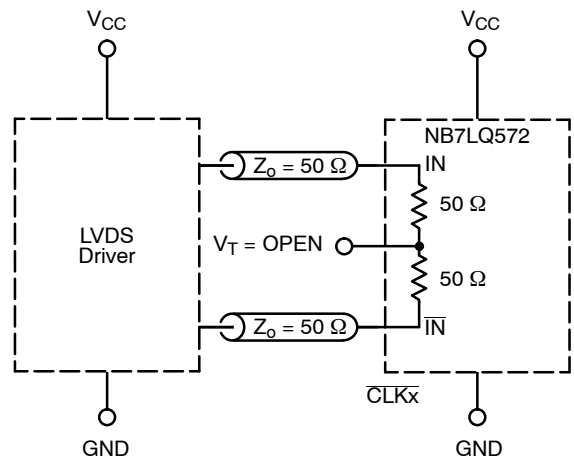


Figure 17. LVDS Interface

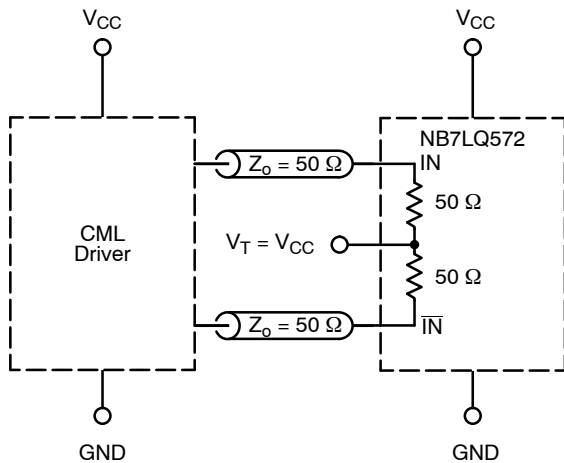


Figure 18. Standard 50 Ω Load CML Interface

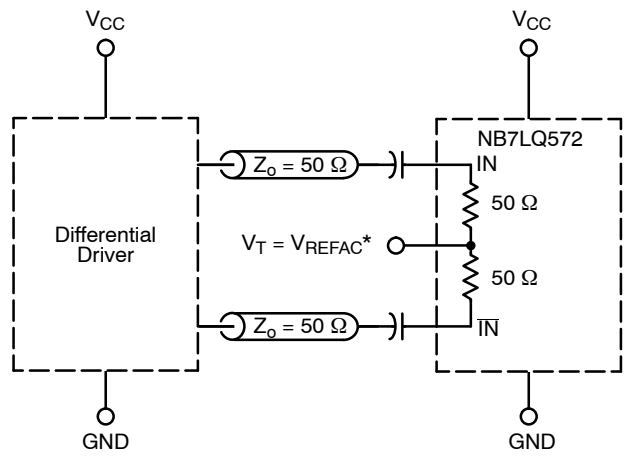


Figure 19. Capacitor-Coupled Differential Interface (V_T Connected to External V_{REFAC})

* V_{REFAC} bypassed to ground with a 0.01 μ F capacitor.

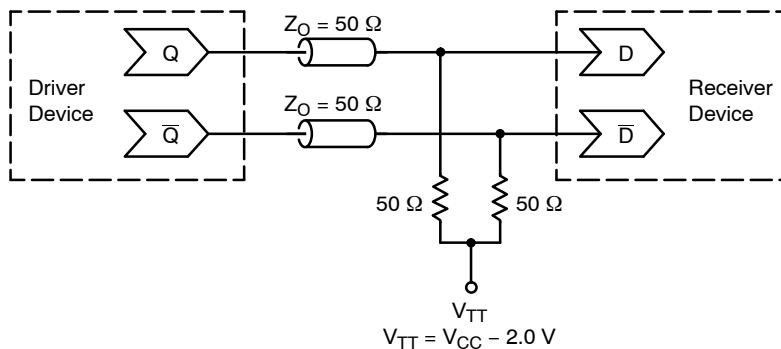


Figure 20. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020/D – Termination of ECL Logic Devices)

NB7LQ572

DEVICE ORDERING INFORMATION

Device	Package	Shipping†
NB7LQ572MNG	QFN-32 (Pb-Free)	74 Units / Rail
NB7LQ572MNR4G	QFN-32 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

